

HYSOL[®] Electrical/Electronic Formulated Liquid Products

One Component Epoxies

System	Description	Typical Applications
HYSOL [®] EO0104	A one-component casting compound that offers thermal shock resistance and flameout properties. It is an extremely stable system at room temperature and offers the handling advantages of a one-component. EO0104 should not be used for casting masses larger than 50 grams.	Potting small modules, connectors and sensors
HYSOL [®] EO0202	A one-component, non-abrasive filled epoxy encapsulant featuring excellent shelf life, thermal shock and chemical resistance. EO0202 should not be used for casting masses larger than 50 grams.	Sealing filter end-caps, general potting

NOTE: Before using these products, consult individual product bulletins and Material Safety Data Sheet for safety and handling information.

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